

BCH-508H- 3 GY PA1,3 - PCB header



1376966

<https://www.phoenixcontact.com/us/products/1376966>

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PCB headers, nominal cross section: 2.5 mm², color: signal gray, nominal current: 12 A, rated voltage (III/2): 320 V, contact surface: Sn, contact connection type: Pin, number of potentials: 2, number of rows: 1, number of positions: 3, number of connections: 2, product range: BCH-H, pitch: 5.08 mm, mounting: Wave soldering, pin layout: Linear pinning, solder pin [P]: 3.23 mm, number of solder pins per potential: 1, plug-in system: BASICLINE 2,5, Pin connector pattern alignment: Standard, locking: without, mounting method: without, type of packaging: packed in cardboard

Your advantages

- Maximum flexibility when it comes to device design – one header for connectors with different connection technologies
- Easy PCB replacement thanks to plug-in modules
- Well-known mounting principle allows worldwide use

Commercial data

Item number	1376966
Packing unit	100 pc
Minimum order quantity	2,000 pc
Note	Made to order (non-returnable)
Product key	AACSQA
GTIN	4063151742126
Weight per piece (including packing)	1.199 g
Weight per piece (excluding packing)	1.16 g
Country of origin	CN

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Technical data

Product properties

Product type	PCB headers
Product family	BCH-H
Product line	COMBICON Connectors M
Number of positions	3
Pitch	5.08 mm
Number of connections	2
Number of rows	1
Number of potentials	2
Pin layout	Linear pinning
Solder pins per potential	1

Electrical properties

Properties

Nominal current I_N	12 A
Nominal voltage U_N	320 V
Contact resistance	2.1 mΩ
Rated voltage (III/3)	250 V
Rated surge voltage (III/3)	4 kV
Rated voltage (III/2)	320 V
Rated surge voltage (III/2)	4 kV
Rated voltage (II/2)	400 V
Rated surge voltage (II/2)	4 kV

Mounting

Mounting type	Wave soldering
Pin layout	Linear pinning

Material specifications

Material data - contact

Note	WEEE/RoHS-compliant, free of whiskers according to IEC 60068-2-82/JEDEC JESD 201
Contact material	Cu alloy
Surface characteristics	Tin-plated
Metal surface contact area (top layer)	Tin (4 μm - 8 μm Sn)
Metal surface contact area (middle layer)	Nickel (1.3 μm - 4 μm Ni)
Metal surface soldering area (top layer)	Tin (4 μm - 8 μm Sn)
Metal surface soldering area (middle layer)	Nickel (1.3 μm - 4 μm Ni)

Material data - housing

Color (Housing)	signal gray (7004)
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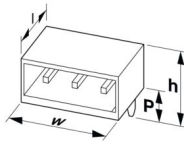
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Insulating material	PA
Insulating material group	I
CTI according to IEC 60112	600
Flammability rating according to UL 94	V0
Glow wire flammability index GWFI according to EN 60695-2-12	850
Glow wire ignition temperature GWIT according to EN 60695-2-13	775
Temperature for the ball pressure test according to EN 60695-10-2	125 °C

Notes

Notes on operation	In accordance with IEC 61984, COMBICON connectors have no switching power (COC). During designated use, they must not be plugged in or disconnected when carrying voltage or under load.
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Dimensions

Dimensional drawing	
Pitch	5.08 mm
Width [w]	15.24 mm
Height [h]	11.8 mm
Length [l]	12 mm
Installed height	8.57 mm
Solder pin length [P]	3.23 mm
Pin dimensions	1 x 1 mm

PCB design

Hole diameter	1.4 mm
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Mechanical tests

Visual inspection

Specification	IEC 60512-1-1:2002-02
Result	Test passed

Dimension check

Specification	IEC 60512-1-2:2002-02
Result	Test passed

Resistance of inscriptions

Specification	IEC 60068-2-70:1995-12
Result	Test passed

Polarization and coding

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Specification	IEC 60512-13-5:2006-02
Result	Test passed

Contact holder in insert

Specification	IEC 60512-15-1:2008-05
Contact holder in insert Requirements >20 N	Test passed

Insertion and withdrawal forces

Specification	IEC 60512-13-2:2006-02
Result	Test passed
No. of cycles	25
Insertion strength per pos. approx.	8 N
Withdraw strength per pos. approx.	6 N

Electrical tests

Thermal test | Test group C

Specification	IEC 60512-5-1:2002-02
Tested number of positions	24

Insulation resistance

Specification	IEC 60512-3-1:2002-02
Insulation resistance, neighboring positions	> 5 MΩ

Air clearances and creepage distances |

Specification	IEC 60664-1:2007-04
Insulating material group	I
Comparative tracking index (IEC 60112)	CTI 600
Rated insulation voltage (III/3)	250 V
Rated surge voltage (III/3)	4 kV
minimum clearance value - non-homogenous field (III/3)	3 mm
minimum creepage distance (III/3)	3.2 mm
Rated insulation voltage (III/2)	320 V
Rated surge voltage (III/2)	4 kV
minimum clearance value - non-homogenous field (III/2)	3 mm
minimum creepage distance (III/2)	3 mm
Rated insulation voltage (II/2)	400 V
Rated surge voltage (II/2)	4 kV
minimum clearance value - non-homogenous field (II/2)	3 mm
minimum creepage distance (II/2)	3 mm

Environmental and real-life conditions

Durability test

Specification	IEC 60512-9-1:2010-03
Impulse withstand voltage at sea level	4.8 kV

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Contact resistance R_1	2.1 m Ω
Contact resistance R_2	2.1 m Ω
Insertion/withdrawal cycles	25
Insulation resistance, neighboring positions	> 5 M Ω

Climatic test

Specification	EN ISO 22479:2022-06
Corrosive stress	0.2 dm ³ SO ₂ on 300 dm ³ /40 °C/1 cycle
Thermal stress	105 °C/168 h
Power-frequency withstand voltage	2.21 kV

Vibration test

Specification	IEC 60068-2-6:2007-12
Frequency	10 - 150 - 10 Hz
Sweep speed	1 octave/min
Amplitude	0.35 mm (10 Hz ... 60.1 Hz)
Acceleration	5g (60.1 Hz ... 150 Hz)
Test duration per axis	2.5 h
Test directions	X-, Y- and Z-axis

Ambient conditions

Ambient temperature (storage/transport)	-40 °C ... 70 °C
Relative humidity (storage/transport)	30 % ... 70 %
Ambient temperature (assembly)	-5 °C ... 100 °C
Ambient temperature (operation)	-40 °C ... 105 °C (dependent on the derating curve)

Packaging specifications

Type of packaging	packed in cardboard
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Drawings

Diagram



Type: BCP-508-... with BCH-508H-...

Diagram



Type: BCS-508-... with BCH-508H-...

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Classifications

ECLASS

ECLASS-13.0	27460201
ECLASS-15.0	27460201

ETIM

ETIM 10.0	EC002637
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UNSPSC

UNSPSC 21.0	39121400
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Environmental product compliance

EU RoHS

Fulfills EU RoHS substance requirements	Yes, No exemptions
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China RoHS

Environment friendly use period (EFUP)	EFUP-E
	No hazardous substances above the limits

EU REACH SVHC

REACH candidate substance (CAS No.)	No substance above 0.1 wt%
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EF3.1 Climate Change

CO2e kg	0.019 kg CO2e
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